

10A,150V Schottky Barrier Rectifier

Features

- Low leakage current
- Schottky barrier diode
- Low forward voltage drop
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260°C/10 seconds



RoHS
COMPLIANT



eSGC (TO-277B)

Applications

For use of fast switching in RF module, lighting, cellular phone, portable device, power supplies, other consumer applications.

Maximum Ratings & Electrical Characteristics (T _A =25°C unless otherwise noted)			
Parameter	Symbol	SGC101B5S	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	150	V
Maximum RMS voltage	V _{RMS}	105	V
Maximum DC blocking voltage	V _{DC}	150	V
Maximum average forward rectified current	I _{F(AV)}	10	A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	175	A
Operating junction temperature range	T _J	-55 to +150	°C
Storage temperature range	T _{STG}	-55 to +150	°C

Thermal-Mechanical Specifications (T _A =25°C unless otherwise noted)			
Parameter	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient	R _{thJA}	40	°C /W
Thermal Resistance, Junction to Case	R _{thJC}	15	°C /W
Thermal Resistance, Junction to Lead	R _{thJL}	7	°C /W

Electrical Specifications (T_A=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions		Typ	Max	Unit
Forward drop voltage	V _F	I _F =1A	T _A =25°C	0.60	0.65	V
		I _F =2A		0.67	0.75	
		I _F =5A		0.75	0.80	
		I _F =10A		0.81	0.85	
		I _F =1A	T _A =125°C	0.47	0.52	
		I _F =2A		0.54	0.60	
		I _F =5A		0.61	0.65	
		I _F =10A		0.68	0.75	
Reverse leakage current @V _R	I _R	T _J =25°C		-	0.1	mA
		T _J =125°C		-	20	
Junction capacitance	C _J	V _R =4.0V, f=1MHZ		240	-	pF

Note:

1. Mounted on copper pad area of 30 x 30mm to each terminal.

Ratings and Characteristics Curves ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

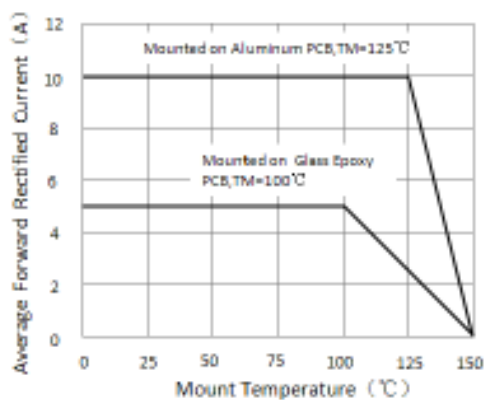


Figure 1. Forward Current Derating Curve

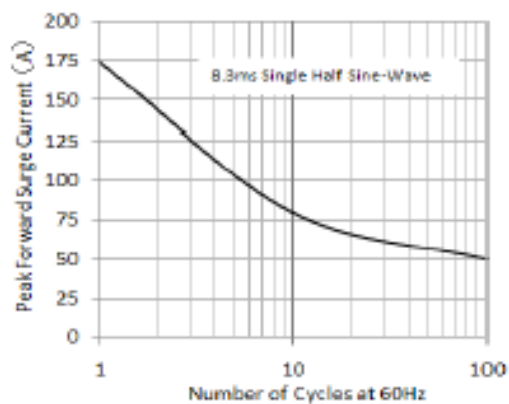


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

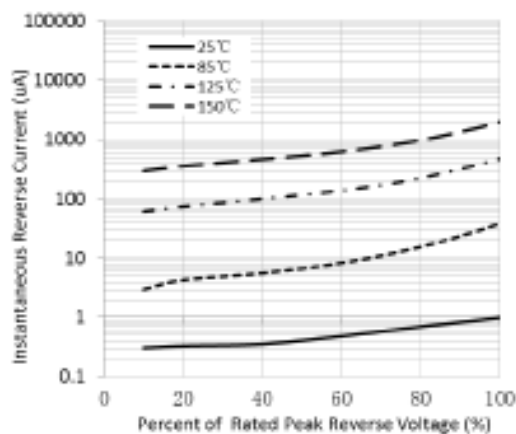


Figure 3. Typical Reverse Characteristics

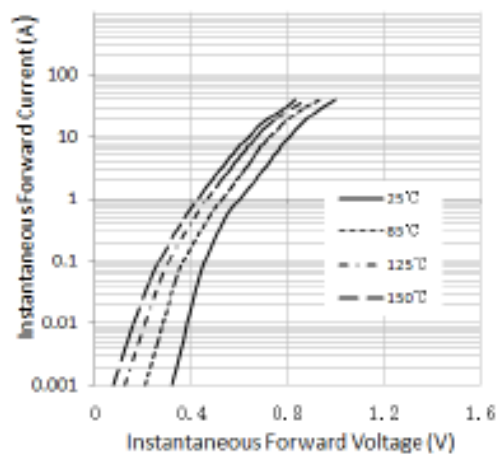


Figure 4. Typical Instantaneous Forward Characteristics

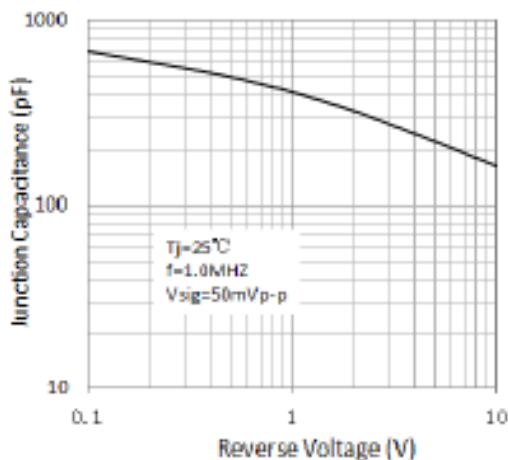
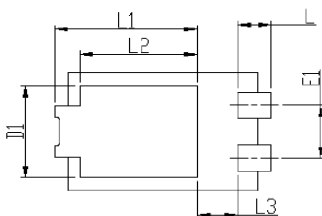
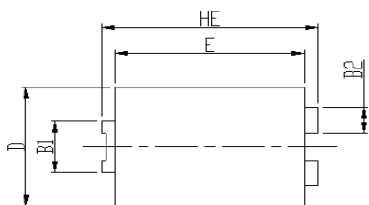


Figure 5. Typical Junction Capacitance

Package Outline Dimensions

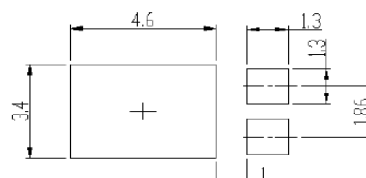
in inches (millimeters)

eSGC (TO-277B)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.1	4.3	0.161	0.169
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52 Typ.		0.139 Typ.	
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86 Typ.		0.073 Typ.	

Soldering footprint



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